

OSRAM LW Y8SD

Datasheet

Preliminary datasheet version

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Micro SIDELED® 3010

LW Y8SD

Micro SIDELED is a SMT LED with side emission. Due to its low package height it is ideal for applications in limited space environments.



Applications

- Access Control & Security
- Appliances & Tools
- Computing
- Display Backlighting
- Home & Building Automation
- Robotics
- Smart Surface
- Visualization

Features

- Package: white SMT package, colored diffused silicone resin
- Chip technology: ThinGaN
- Typ. Radiation: 120° (horizontal = 0°), 120° (vertical = 90°)
- Color: Cx = 0.31, Cy = 0.29 acc. to CIE 1931 (● white)
- Corrosion Robustness Class: 2B
- Qualifications: The product qualification test plan is based on the guidelines of AEC-Q101-REV-C, Stress Test Qualification for Automotive Grade Discrete Semiconductors.
- ESD: 2 kV acc. to ANSI/ESDA/JEDEC JS-001 (HBM)

Ordering Information

Type	Luminous Intensity ¹⁾ $I_F = 10\text{ mA}$ I_v	Ordering Code
LW Y8SD-T2V1-IK0ML0	355 ... 900 mcd	Q65113A7341

Maximum Ratings

Parameter	Symbol		Values
Operating Temperature	T_{op}	min.	-40 °C
		max.	100 °C
Storage Temperature	T_{stg}	min.	-40 °C
		max.	100 °C
Junction Temperature	T_j	max.	110 °C
Forward current $T_s = 25\text{ °C}$	I_F	min.	1 mA
		max.	20 mA
Forward current pulsed $D = 0.005$; $T_s = 25\text{ °C}$	$I_{F\ pulse}$	max.	200 mA
Surge current $t \leq 10\text{ }\mu\text{s}$; $D = 0.005$; $T_s = 25\text{ °C}$	I_{FS}	max.	200 mA
Reverse voltage ²⁾ $T_s = 25\text{ °C}$	V_R	max.	5 V
ESD withstand voltage acc. to ANSI/ESDA/JEDEC JS-001 (HBM)	V_{ESD}		2 kV

Characteristics

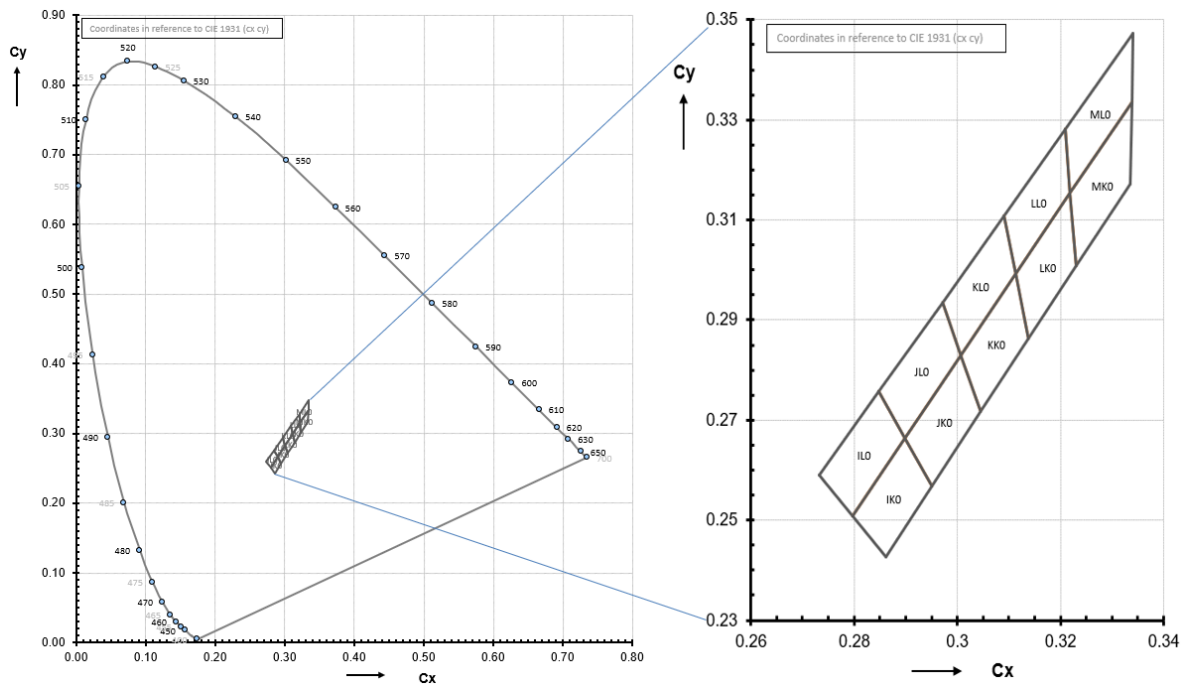
$I_F = 10\text{ mA}$; $T_s = 25\text{ °C}$

Parameter	Symbol		Values
Chromaticity Coordinate ³⁾	Cx	typ.	0.31
	Cy	typ.	0.29
Viewing angle at 50% I_V values for 0°, 90°	2φ	typ.	120 °
		typ.	120 °
Forward Voltage ⁴⁾ $I_F = 10\text{ mA}$	V_F	min.	2.70 V
		typ.	2.80 V
		max.	3.25 V
Reverse current ²⁾ $V_R = 5\text{ V}$	I_R	typ.	0.01 μA
		max.	10 μA
Real thermal resistance junction/solderpoint ⁵⁾	$R_{thJS\text{ real}}$	typ.	140 K / W
		max.	240 K / W

Brightness Groups

Group	Luminous Intensity ¹⁾ $I_F = 10\text{ mA}$ min. I_v	Luminous Intensity ¹⁾ $I_F = 10\text{ mA}$ max. I_v	Luminous Flux ⁶⁾ $I_F = 10\text{ mA}$ typ. Φ_v
T2	355 mcd	450 mcd	1210 mlm
U1	450 mcd	560 mcd	1520 mlm
U2	560 mcd	710 mcd	1910 mlm
V1	710 mcd	900 mcd	2420 mlm

Chromaticity Coordinate Groups ³⁾



Chromaticity Coordinate Groups ³⁾

Group	Cx	Cy	Group	Cx	Cy	Group	Cx	Cy
IK0	0.2797	0.2509	KK0	0.3007	0.2830	MK0	0.3219	0.3154
	0.2898	0.2664		0.3113	0.2992		0.3339	0.3336
	0.2950	0.2568		0.3138	0.2862		0.3335	0.3172
	0.2861	0.2427		0.3045	0.2717		0.3231	0.3008
IL0	0.2733	0.2590	KLO	0.2971	0.2935	MLO	0.3209	0.3281
	0.2848	0.2757		0.3090	0.3108		0.3341	0.3472
	0.2898	0.2664		0.3113	0.2992		0.3339	0.3336
	0.2797	0.2509		0.3007	0.2830		0.3219	0.3154
JK0	0.2898	0.2664	LK0	0.3113	0.2992			
	0.3007	0.2830		0.3219	0.3154			
	0.3045	0.2717		0.3231	0.3008			
	0.2950	0.2568		0.3138	0.2862			
JLO	0.2848	0.2757	LLO	0.3090	0.3108			
	0.2971	0.2935		0.3209	0.3281			
	0.3007	0.2830		0.3219	0.3154			
	0.2898	0.2664		0.3113	0.2992			

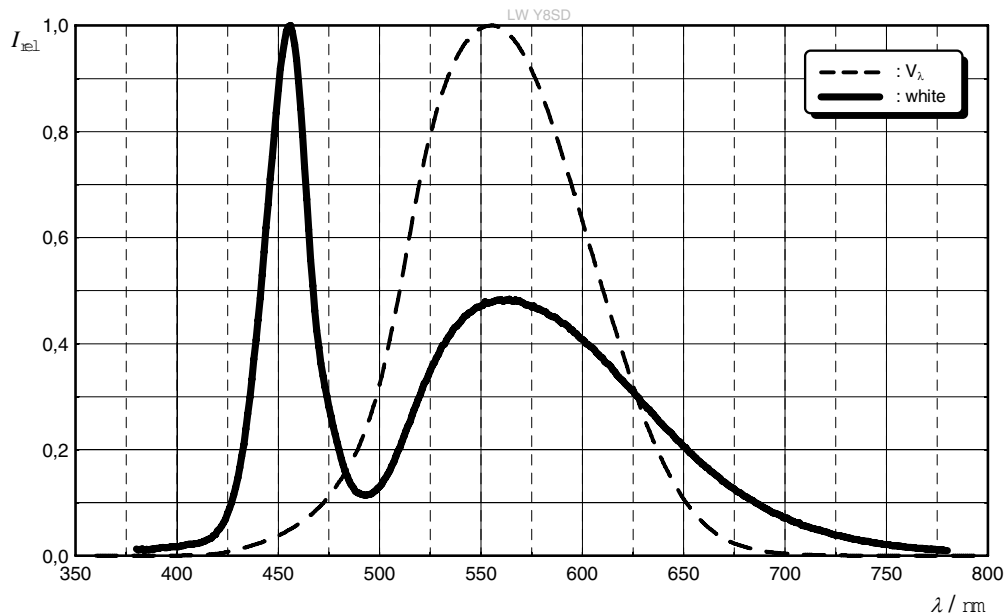
Group Name on Label

Example: T2-IK0

Brightness	Color Chromaticity
T2	IK0

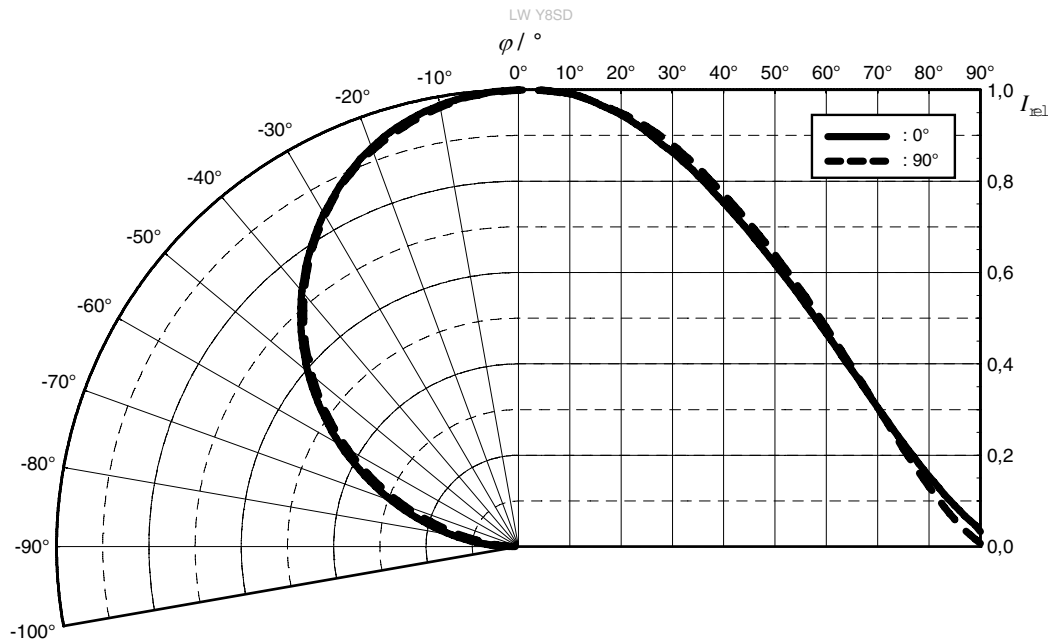
Relative Spectral Emission ⁶⁾

$I_{\text{rel}} = f(\lambda); I_{\text{F}} = 10 \text{ mA}; T_{\text{S}} = 25 \text{ °C}$



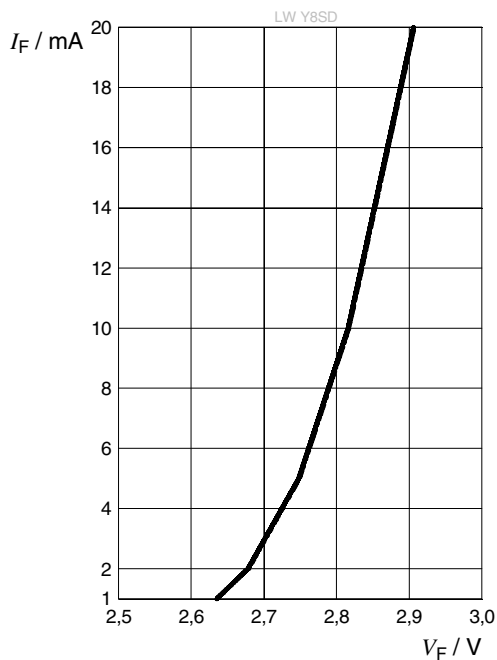
Radiation Characteristics ⁶⁾

$I_{\text{rel}} = f(\varphi); T_{\text{S}} = 25 \text{ °C}$



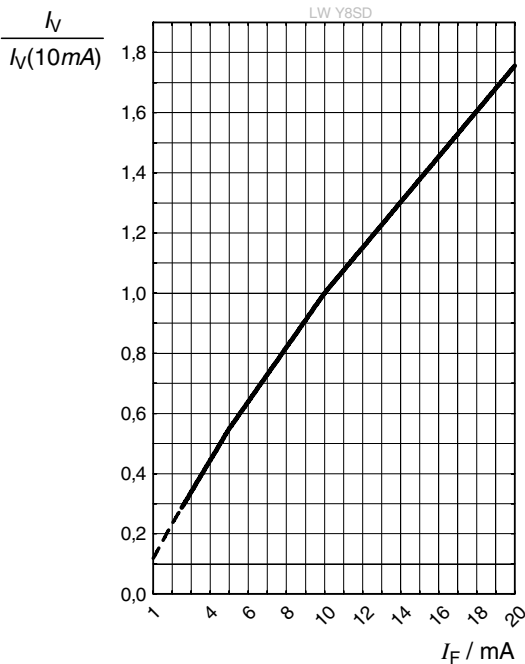
Forward current ⁶⁾

$I_F = f(V_F); T_S = 25\text{ °C}$



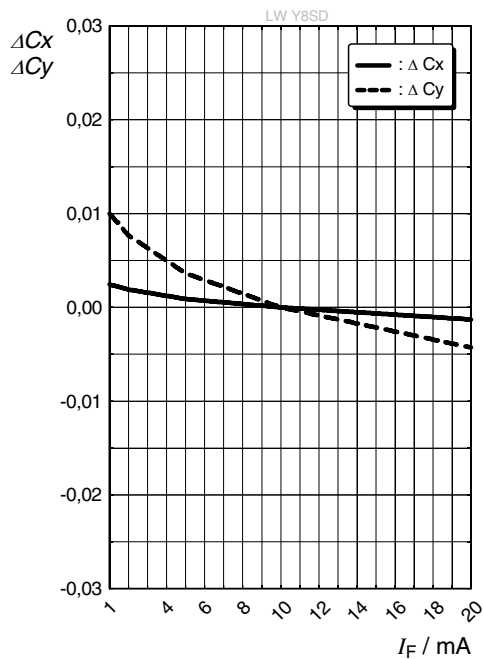
Relative Luminous Intensity ^{6), 7)}

$I_V/I_V(10\text{ mA}) = f(I_F); T_S = 25\text{ °C}$



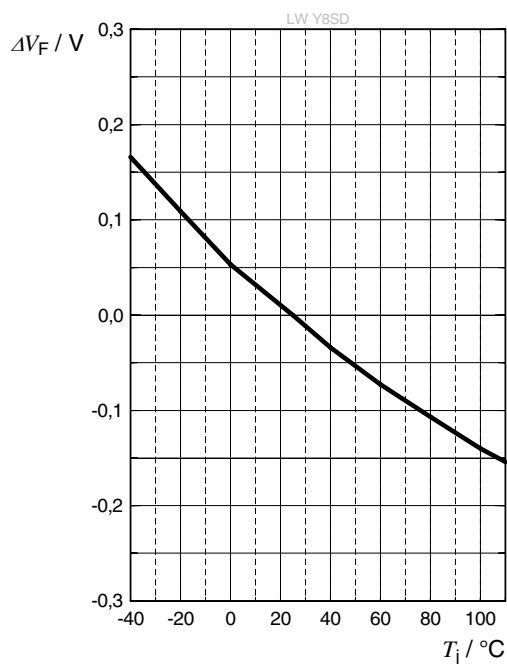
Chromaticity Coordinate Shift ⁶⁾

$C_x, C_y = f(I_F); T_S = 25\text{ °C}$

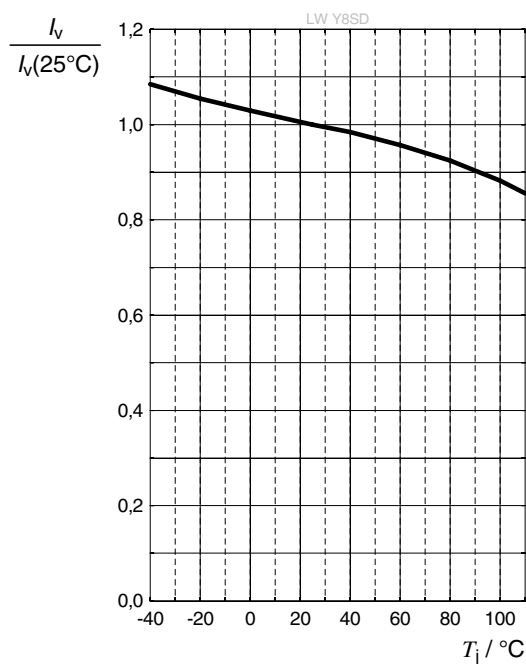


Forward Voltage ⁶⁾

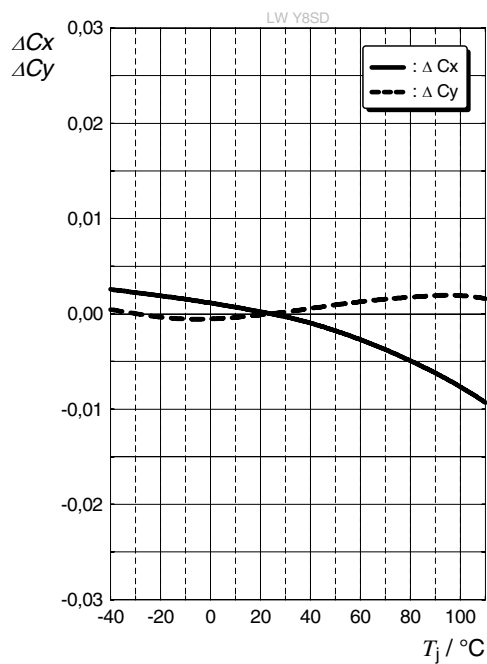
$$\Delta V_F = V_F - V_F(25^\circ\text{C}) = f(T_j); I_F = 10\text{ mA}$$

**Relative Luminous Intensity** ⁶⁾

$$I_V / I_V(25^\circ\text{C}) = f(T_j); I_F = 10\text{ mA}$$

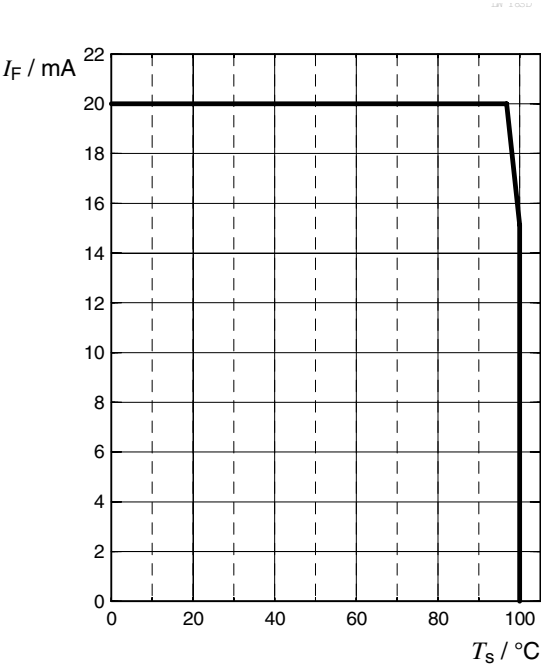
**Chromaticity Coordinate Shift** ⁶⁾

$$C_x, C_y = f(T_j); I_F = 10\text{ mA}$$



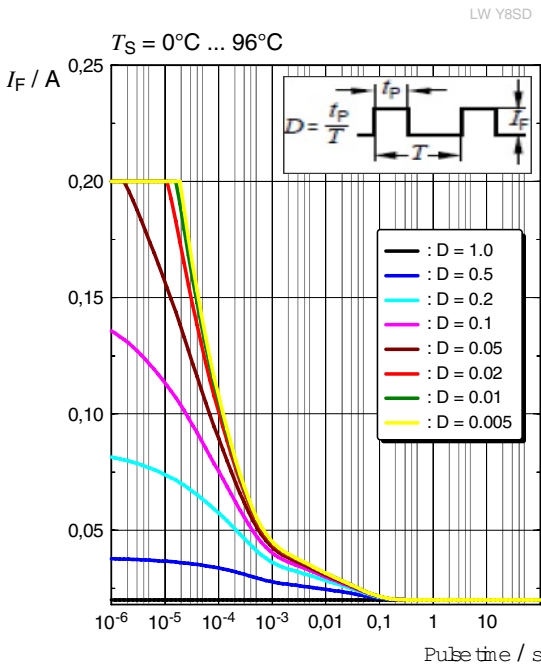
Max. Permissible Forward Current ⁵⁾

$I_F = f(T)$



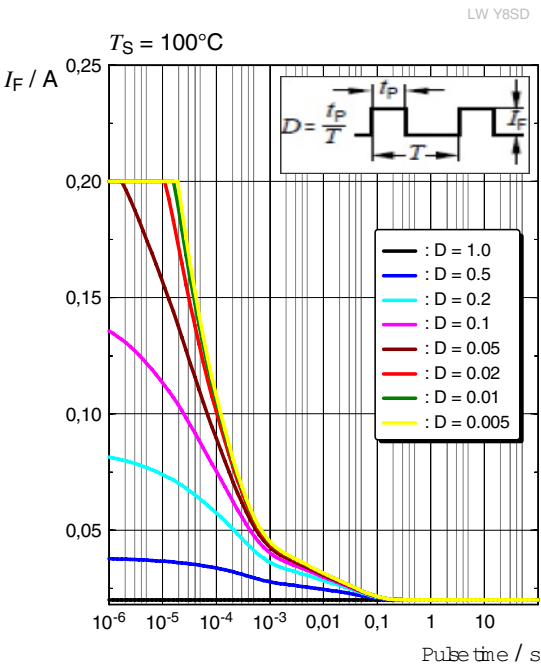
Permissible Pulse Handling Capability

$I_F = f(t_p)$; D: Duty cycle; $T_s = 25^\circ\text{C}$

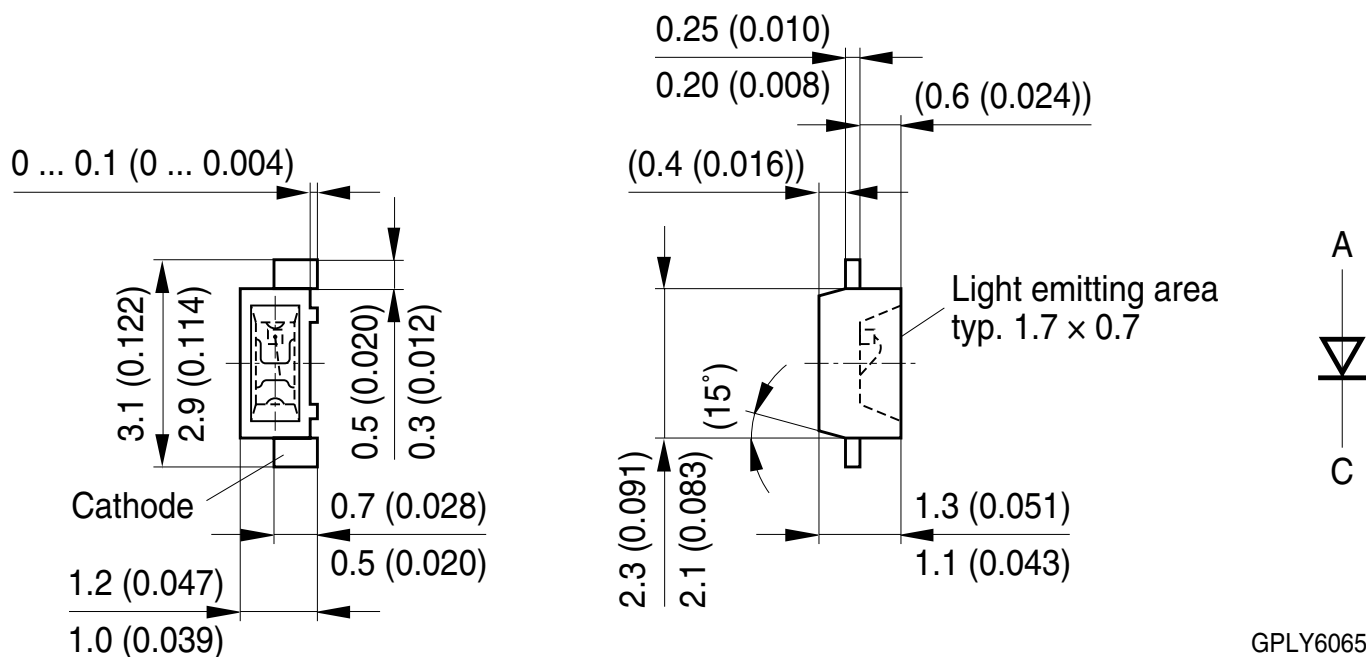


Permissible Pulse Handling Capability

$I_F = f(t_p)$; D: Duty cycle; $T_s = 85^\circ\text{C}$



Dimensional Drawing ⁸⁾



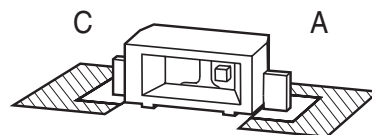
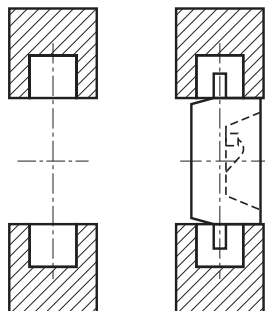
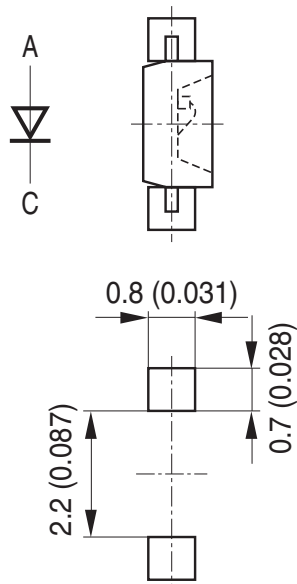
Further Information:

Approximate Weight: 6.0 mg

Corrosion test: Class: 2B
Test condition: 25°C / 75 % RH / 10 ppm H₂S / 21 days (IEC 60068-2-43)

Recommended Solder Pad ⁸⁾

Bauteil positioniert
Component location on pad



Padgeometrie für
verbesserte Wärmeableitung

Paddesign for improved
heat dissipation

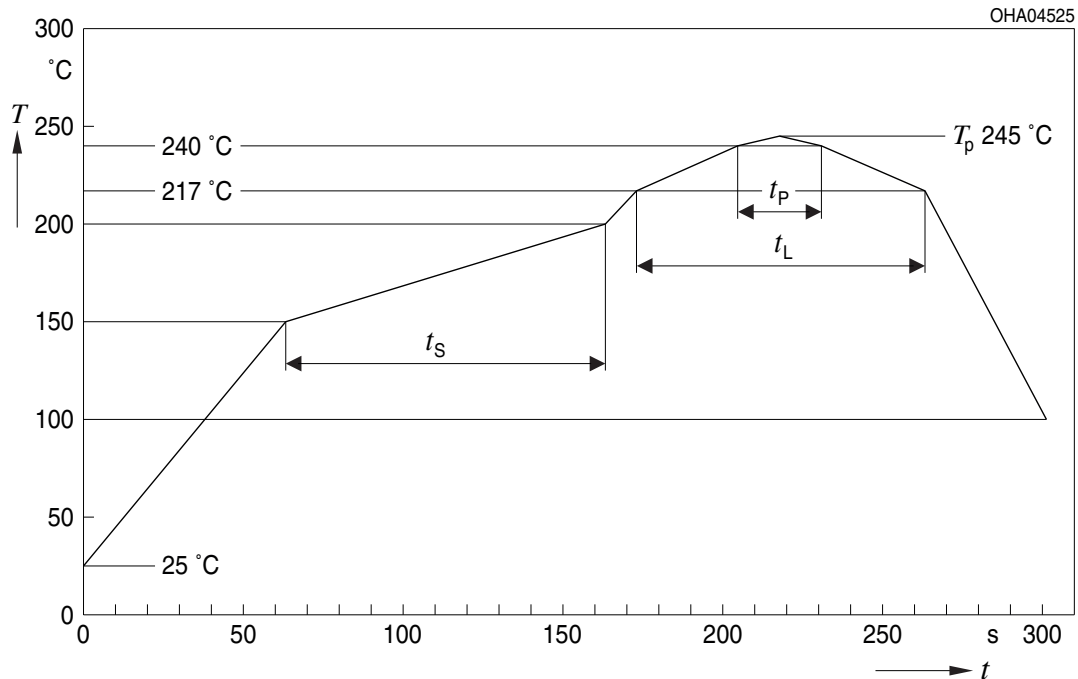
 Lötstopplack
Solder resist

OHPY1316

For superior solder joint connectivity results we recommend soldering under standard nitrogen atmosphere. Package not suitable for ultra sonic cleaning.

Reflow Soldering Profile

Product complies to MSL Level 4 acc. to JEDEC J-STD-020E

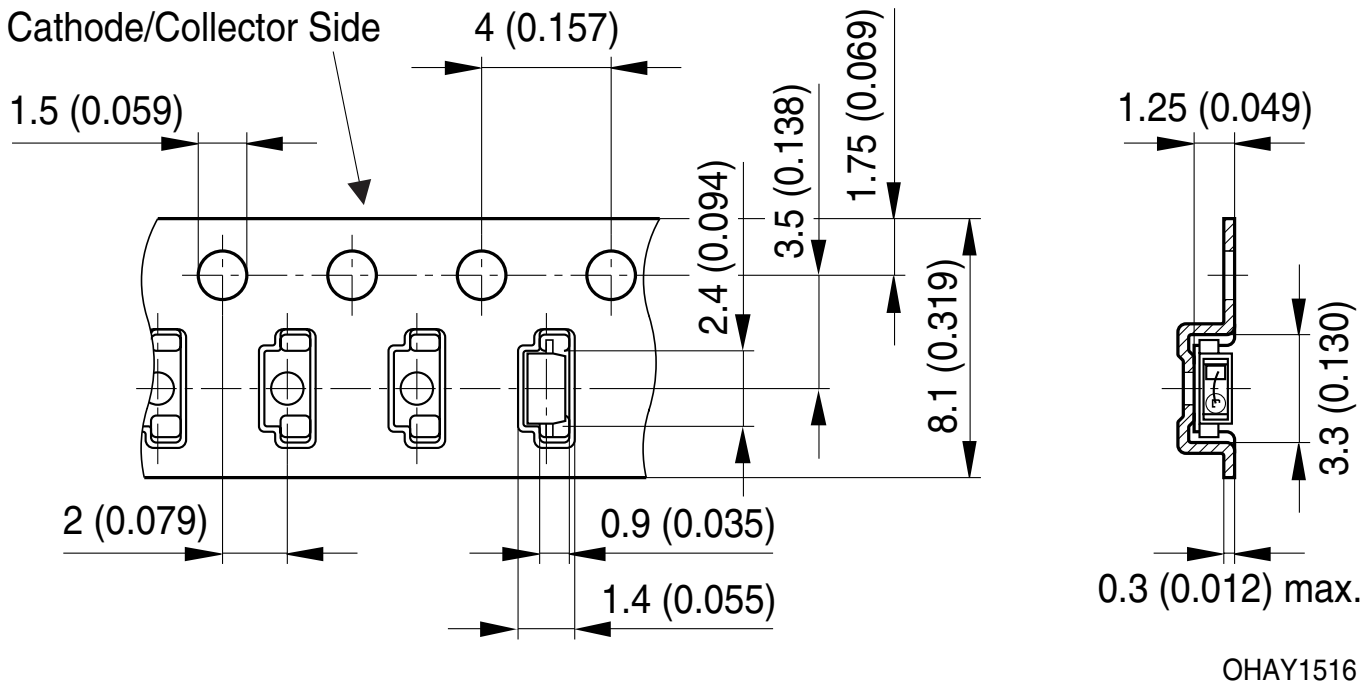


Profile Feature	Symbol	Pb-Free (SnAgCu) Assembly			Unit
		Minimum	Recommendation	Maximum	
Ramp-up rate to preheat*) 25 °C to 150 °C			2	3	K/s
Time t_s T_{Smin} to T_{Smax}	t_s	60	100	120	s
Ramp-up rate to peak*) T_{Smax} to T_p			2	3	K/s
Liquidus temperature	T_L		217		$^{\circ}\text{C}$
Time above liquidus temperature	t_L		80	100	s
Peak temperature	T_p		245	260	$^{\circ}\text{C}$
Time within 5 °C of the specified peak temperature $T_p - 5\text{ K}$	t_p	10	20	30	s
Ramp-down rate*) T_p to 100 °C			3	6	K/s
Time 25 °C to T_p				480	s

All temperatures refer to the center of the package, measured on the top of the component

*) slope calculation DT/Dt : Dt max. 5 s; fulfillment for the whole T-range

Taping ⁸⁾



Tape and Reel ⁹⁾



Reel Dimensions

A	W	N _{min}	W ₁	W _{2 max}	Pieces per PU
180 mm	8 + 0.3 / - 0.1 mm	60 mm	8.4 + 2 mm	14.4 mm	3000

OSRAM

BIN1: XX-XX-X-XXX-X

RoHS Compliant

(6P) BATCH NO: 1234567890



(1T) LOT NO: 1234567890

(9D) D/C: 1234



Pack: RXX

DEMY XXX

X X123 1234.1234 X

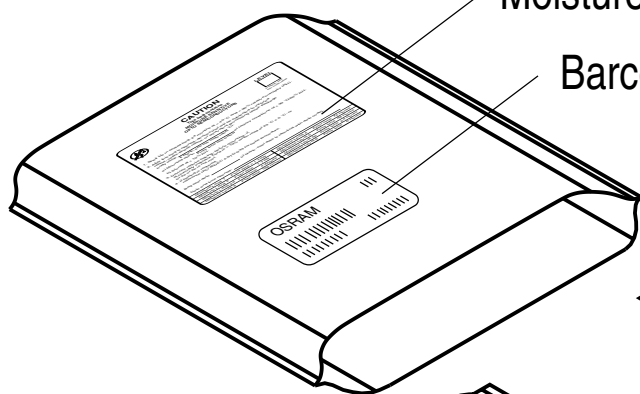


(X) PROD NO: 123456789 (Q) QTY: 9999 (G) GROUP: XX-XX-X-X

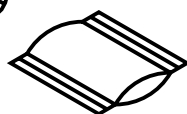


OHA04563

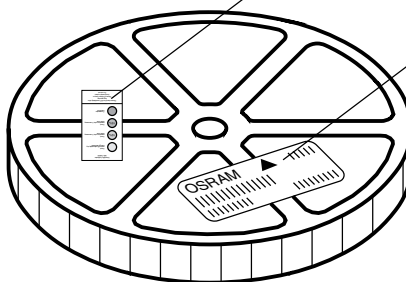
Barcode label



Desiccant



Humidity indicator



Barcode label

OH A00539

Moisture-sensitive product is packed in a dry bag containing desiccant and a humidity card according JEDEC-STD-033.

Notes

The evaluation of eye safety occurs according to the standard IEC 62471:2006 (photo biological safety of lamps and lamp systems). Within the risk grouping system of this IEC standard, the device specified in this data sheet fall into the class **exempt group (exposure time 10000 s)**. Under real circumstances (for exposure time, conditions of the eye pupils, observation distance), it is assumed that no endangerment to the eye exists from these devices. As a matter of principle, however, it should be mentioned that intense light sources have a high secondary exposure potential due to their blinding effect. When looking at bright light sources (e.g. headlights), temporary reduction in visual acuity and afterimages can occur, leading to irritation, annoyance, visual impairment, and even accidents, depending on the situation.

Subcomponents of this device contain, in addition to other substances, metal filled materials including silver. Metal filled materials can be affected by environments that contain traces of aggressive substances. Therefore, we recommend that customers minimize device exposure to aggressive substances during storage, production, and use. Devices that showed visible discoloration when tested using the described tests above did show no performance deviations within failure limits during the stated test duration. Respective failure limits are described in the IEC60810.

For further application related information please visit <https://ams-osram.com/support/application-notes>

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For information on the types in question please contact our Sales Organization.

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Packing

Please use the recycling operators known to you. We can also help you – get in touch with your nearest sales office. By agreement we will take packing material back, if it is sorted. You must bear the costs of transport. For packing material that is returned to us unsorted or which we are not obliged to accept, we shall have to invoice you for any costs incurred.

Product and functional safety devices/applications or medical devices/applications

Our components are not developed, constructed or tested for the application as safety relevant component or for the application in medical devices.

Our products are not qualified at module and system level for such application.

In case buyer – or customer supplied by buyer – considers using our components in product safety devices/applications or medical devices/applications, buyer and/or customer has to inform our local sales partner immediately and we and buyer and /or customer will analyze and coordinate the customer-specific request between us and buyer and/or customer.

Glossary

- 1) **Brightness:** Brightness values are measured during a current pulse of typically 25 ms, with an internal reproducibility of $\pm 8\%$ and an expanded uncertainty of $\pm 11\%$ (acc. to GUM with a coverage factor of $k = 3$).
- 2) **Reverse Operation:** This product is intended to be operated applying a forward current within the specified range. Applying any continuous reverse bias or forward bias below the voltage range of light emission shall be avoided because it may cause migration which can change the electro-optical characteristics or damage the LED.
- 3) **Chromaticity coordinate groups:** Chromaticity coordinates are measured during a current pulse of typically 25 ms, with an internal reproducibility of ± 0.005 and an expanded uncertainty of ± 0.01 (acc. to GUM with a coverage factor of $k = 3$).
- 4) **Forward Voltage:** The forward voltage is measured during a current pulse of typically 8 ms, with an internal reproducibility of $\pm 0.05\text{ V}$ and an expanded uncertainty of $\pm 0.1\text{ V}$ (acc. to GUM with a coverage factor of $k = 3$).
- 5) **Thermal Resistance:** $R_{th\text{ max}}$ is based on statistic values (6σ) used for Derating.
- 6) **Typical Values:** Due to the special conditions of the manufacturing processes of semiconductor devices, the typical data or calculated correlations of technical parameters can only reflect statistical figures. These do not necessarily correspond to the actual parameters of each single product, which could differ from the typical data and calculated correlations or the typical characteristic line. If requested, e.g. because of technical improvements, these typ. data will be changed without any further notice.
- 7) **Characteristic curve:** In the range where the line of the graph is broken, you must expect higher differences between single devices within one packing unit.
- 8) **Tolerance of Measure:** Unless otherwise noted in drawing, tolerances are specified with ± 0.1 and dimensions are specified in mm.
- 9) **Tape and Reel:** All dimensions and tolerances are specified acc. IEC 60286-3 and specified in mm.

Revision History

Version	Date	Change
0.0	2024-05-09	Initial Version

Preliminary datasheet version



EU RoHS and China RoHS compliant product

此产品符合欧盟 RoHS 指令的要求；
按照中国的相关法规和标准，
不含有毒有害物质或元素。

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am The logo for ams, consisting of the letters 'am' in a bold, sans-serif font, followed by a stylized graphic of a grid or circuit pattern.

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